

# SANYO Semiconductors DATA SHEET

An ON Semiconductor Company

1SV246 — Silicon Epitaxial Type

### PIN Diode for VHF, UHF, AGC Applications

#### **Features**

- Series connection of 2 elements in a very small-sized package facilitates high-density mounting and permits 1SV246-applied equipment to be made smaller
- Small interterminal capacitance (C=0.23pF typ)
- Small forward series resistance ( $r_S=5\Omega$  typ)

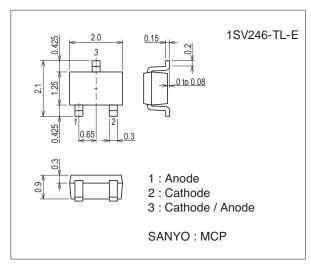
#### **Specifications**

#### Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Reverse Voltage	VR		50	V
Forward Current	lF		50	mA
Allowable Power Dissipation	Р		100	mW
Junction Temperature	Tj		125	C
Storage Temperature	Tstg		-55 to +125	$^{\circ}$

#### **Package Dimensions**

unit : mm (typ) 7023A-007

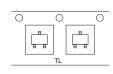


#### **Product & Package Information**

• Package : MCP

JEITA, JEDEC : SC-70, SOT-323
 Minimum Packing Quantity : 3,000 pcs./reel

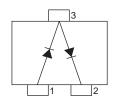
#### **Packing Type: TL**



## LOT No. |

Marking

#### **Electrical Connection**



#### 1SV246

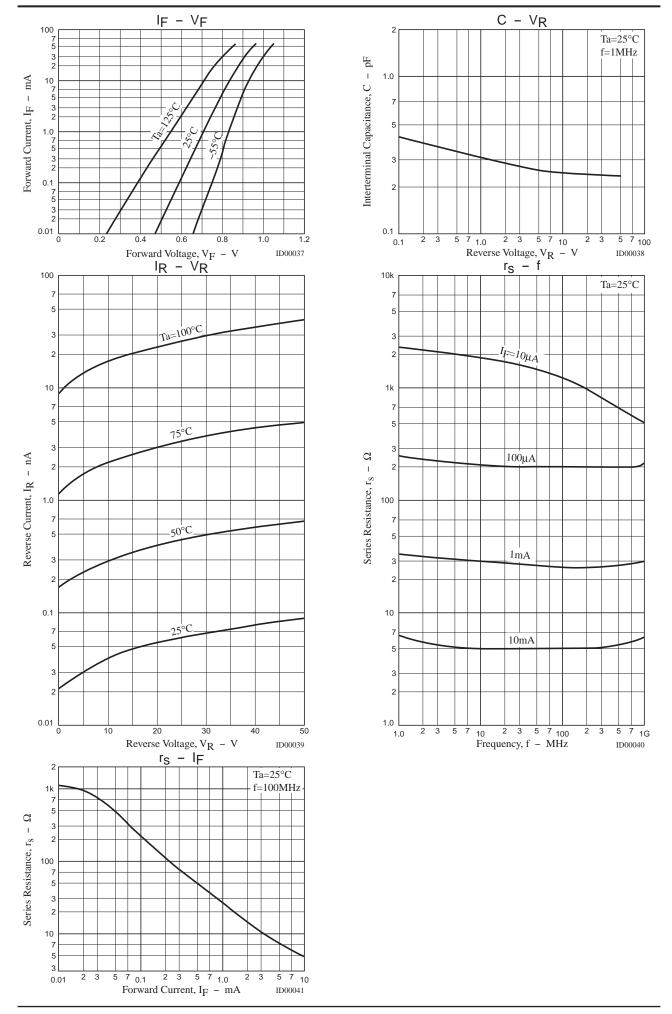
#### **Electrical Characteristics** at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	Onit
Reverse Voltage	VR	I <sub>R</sub> =10μA	50			V
Reverse Current	IR	V <sub>R</sub> =50V			0.1	μΑ
Forward Voltage	VF	I <sub>F</sub> =50mA		0.95		V
Interterminal Capacitance	С	V <sub>R</sub> =50V, f=1MHz		0.23		pF
Series Resistance	r <sub>S</sub>	IF=10mA, f=100MHz		5.0		Ω

Note: The specifications shown above are for each individual diode.

### **Ordering Information**

Device	Package	Shipping	memo	
1SV246-TL-E	1SV246-TL-E MCP		Pb Free	

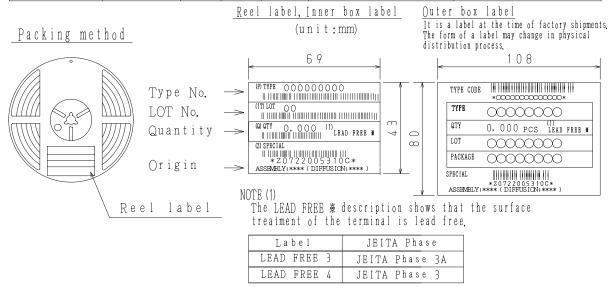


#### **Embossed Taping Specification**

#### 1SV246-TL-E

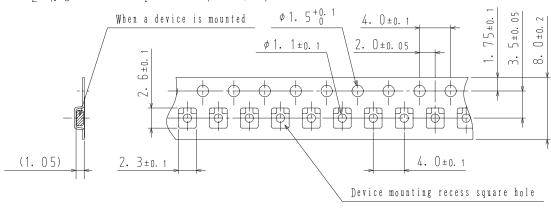
#### 1. Packing Format

Package Name	Carrier Tape	Maximum Number of devices contained (pcs)			Packing	format		
	Туре	Reel	Inner box	Outer box	Inner BOX (C-1)	Outer BOX (A-7)		
MCP	MCP	3, 000	15, 000	90,000	5 reels contained	6 inner boxes contained		
					Dimensions:mm (external)	Dimensions:mm (external)		
					183×72×185	440×195×210		

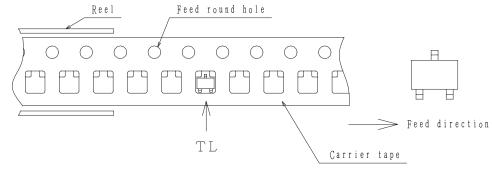


#### 2. Taping configuration

2-1. Carrier tape size (unit:mm)



2-2. Device placement direction



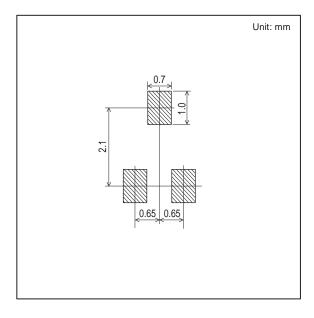
Those with oen electrode terminal on the feed hole side·····TL

#### **Outline Drawing**

1SV246-TL-E

## 

#### **Land Pattern Example**



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